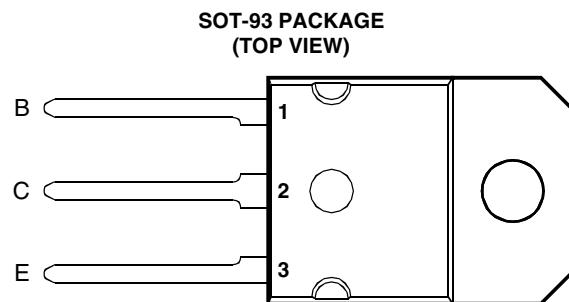


- Rugged Triple-Diffused Planar Construction
- 4 A Continuous Collector Current
- Operating Characteristics Fully Guaranteed at 100°C
- 1000 Volt Blocking Capability
- 100 W at 25°C Case Temperature



Pin 2 is in electrical contact with the mounting base.

MDTRAAA

#### absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ( $I_E = 0$ )	TIPL761 TIPL761A	$V_{CBO}$	850 1000	V
Collector-emitter voltage ( $V_{BE} = 0$ )	TIPL761 TIPL761A	$V_{CES}$	850 1000	V
Collector-emitter voltage ( $I_B = 0$ )	TIPL761 TIPL761A	$V_{CEO}$	400 450	V
Emitter-base voltage		$V_{EBO}$	10	V
Continuous collector current		$I_C$	4	A
Peak collector current (see Note 1)		$I_{CM}$	8	A
Continuous device dissipation at (or below) 25°C case temperature		$P_{tot}$	100	W
Operating junction temperature range		$T_j$	-65 to +150	°C
Storage temperature range		$T_{stg}$	-65 to +150	°C

NOTE 1: This value applies for  $t_p \leq 10$  ms, duty cycle  $\leq 2\%$ .

#### PRODUCT INFORMATION

**electrical characteristics at 25°C case temperature (unless otherwise noted)**

PARAMETER	TEST CONDITIONS				MIN	TYP	MAX	UNIT
$V_{CEO(sus)}$	$I_C = 10 \text{ mA}$	$L = 25 \text{ mH}$	(see Note 2)	TIPL761 TIPL761A	400 450			V
$I_{CES}$	$V_{CE} = 850 \text{ V}$ $V_{CE} = 1000 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$		TIPL761 TIPL761A		50 50	200 200	$\mu\text{A}$
$I_{CEO}$	$V_{CE} = 850 \text{ V}$ $V_{CE} = 1000 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$	$T_C = 100^\circ\text{C}$ $T_C = 100^\circ\text{C}$	TIPL761 TIPL761A				$\mu\text{A}$
$I_{EBO}$	$V_{CE} = 400 \text{ V}$ $V_{CE} = 450 \text{ V}$	$I_B = 0$ $I_B = 0$		TIPL761 TIPL761A		50 50	50 50	$\mu\text{A}$
$h_{FE}$	$V_{CE} = 5 \text{ V}$	$I_C = 0.5 \text{ A}$	(see Notes 3 and 4)		20		60	
$V_{CE(sat)}$	$I_B = 0.5 \text{ A}$ $I_B = 0.8 \text{ A}$ $I_B = 0.8 \text{ A}$	$I_C = 2.5 \text{ A}$ $I_C = 4 \text{ A}$ $I_C = 4 \text{ A}$	(see Notes 3 and 4) $T_C = 100^\circ\text{C}$			1.0 2.5 5.0		V
$V_{BE(sat)}$	$I_B = 0.5 \text{ A}$ $I_B = 0.8 \text{ A}$ $I_B = 0.8 \text{ A}$	$I_C = 2.5 \text{ A}$ $I_C = 4 \text{ A}$ $I_C = 4 \text{ A}$	(see Notes 3 and 4) $T_C = 100^\circ\text{C}$			1.2 1.4 1.3		V
$f_t$	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$			12		MHz
$C_{ob}$	$V_{CB} = 20 \text{ V}$	$I_E = 0$	$f = 0.1 \text{ MHz}$			110		pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques,  $t_p = 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

**thermal characteristics**

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.25	°C/W

**inductive-load-switching characteristics at 25°C case temperature (unless otherwise noted)**

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
$t_{sv}$	$I_C = 4 \text{ A}$ $V_{BE(off)} = -5 \text{ V}$	$I_{B(on)} = 0.8 \text{ A}$	(see Figures 1 and 2)			2.5	$\mu\text{s}$
$t_{rv}$						300	ns
$t_{fi}$						250	ns
$t_{ti}$						150	ns
$t_{xo}$						400	ns
$t_{sv}$	$I_C = 4 \text{ A}$ $V_{BE(off)} = -5 \text{ V}$	$I_{B(on)} = 0.8 \text{ A}$ $T_C = 100^\circ\text{C}$	(see Figures 1 and 2)			3	$\mu\text{s}$
$t_{rv}$						500	ns
$t_{fi}$						250	ns
$t_{ti}$						150	ns
$t_{xo}$						750	ns

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

**PRODUCT INFORMATION**

AUGUST 1978 - REVISED SEPTEMBER 2002  
 Specifications are subject to change without notice.

## PARAMETER MEASUREMENT INFORMATION

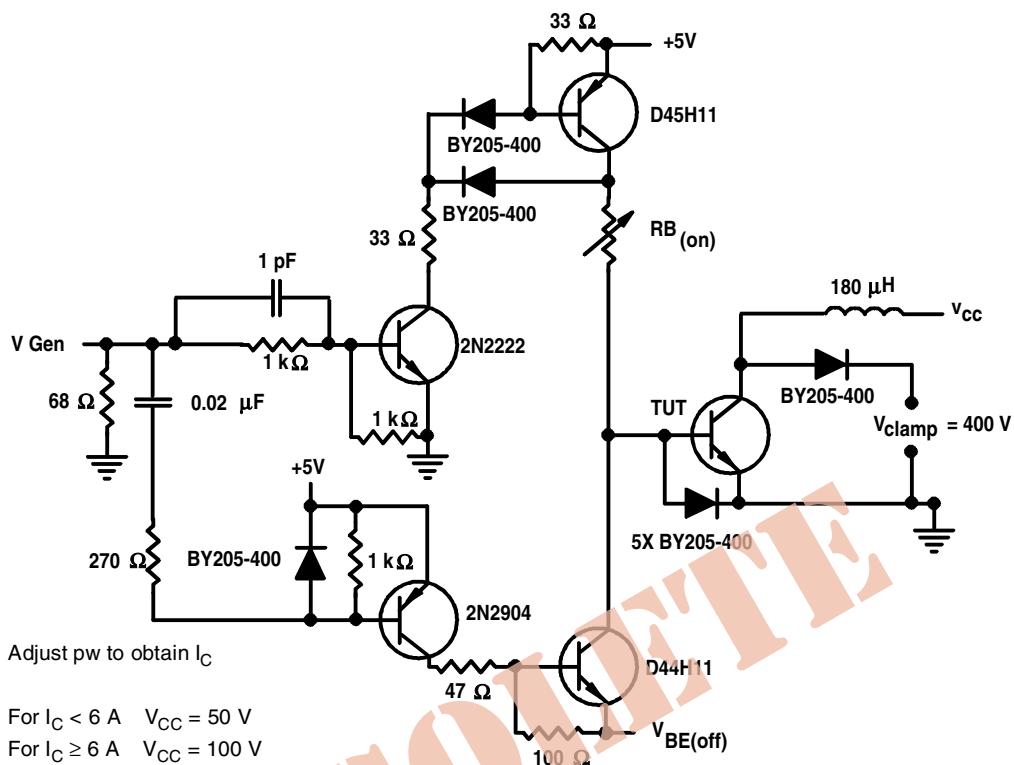
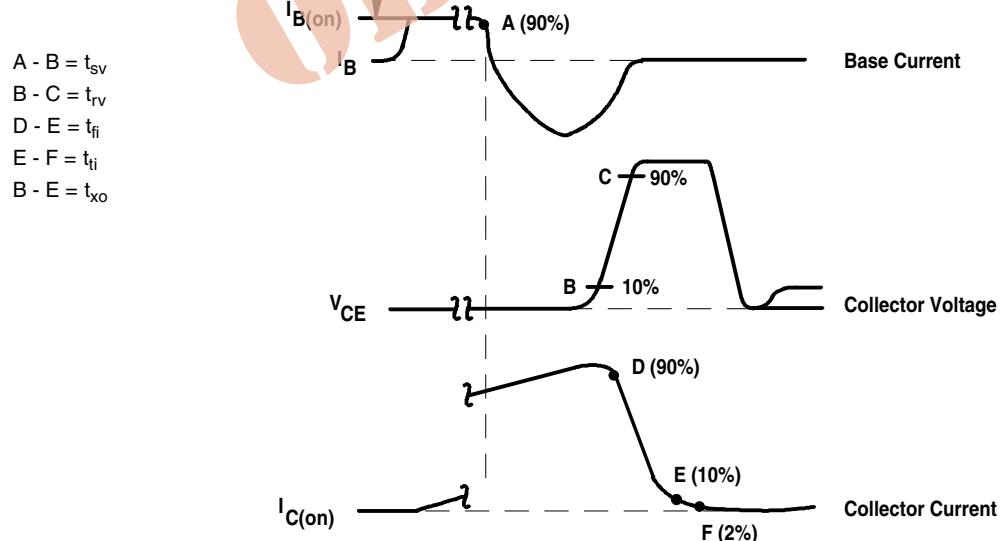


Figure 1. Inductive-Load Switching Test Circuit



NOTES: A. Waveforms are monitored on an oscilloscope with the following characteristics:  $t_r < 15$  ns,  $R_{in} > 10 \Omega$ ,  $C_{in} < 11.5$  pF.  
 B. Resistors must be noninductive types.

Figure 2. Inductive-Load Switching Waveforms

## PRODUCT INFORMATION

TYPICAL CHARACTERISTICS

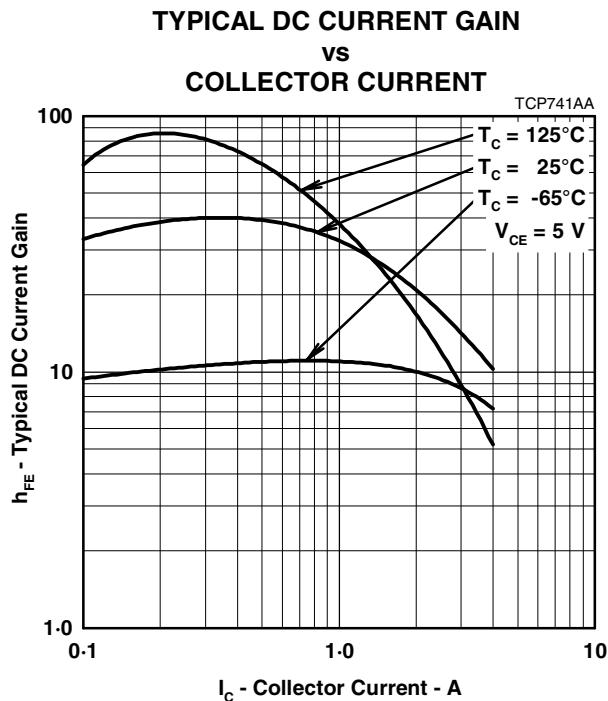


Figure 3.

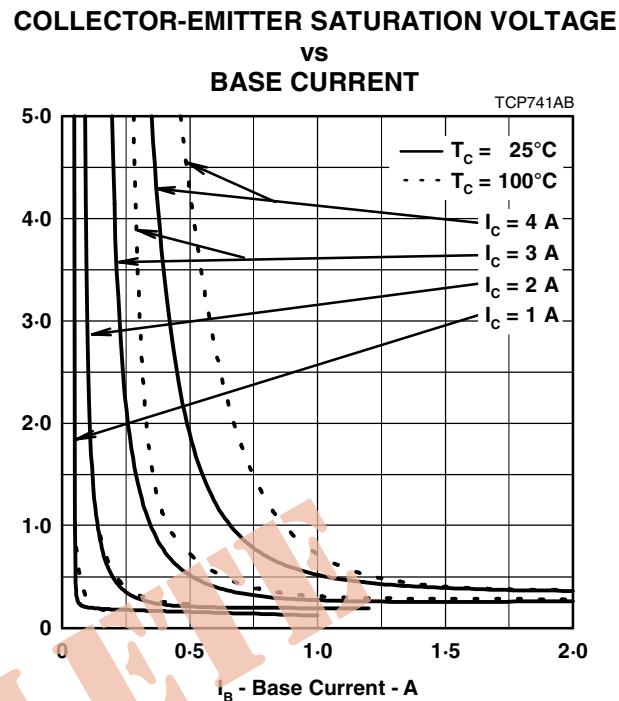


Figure 4.

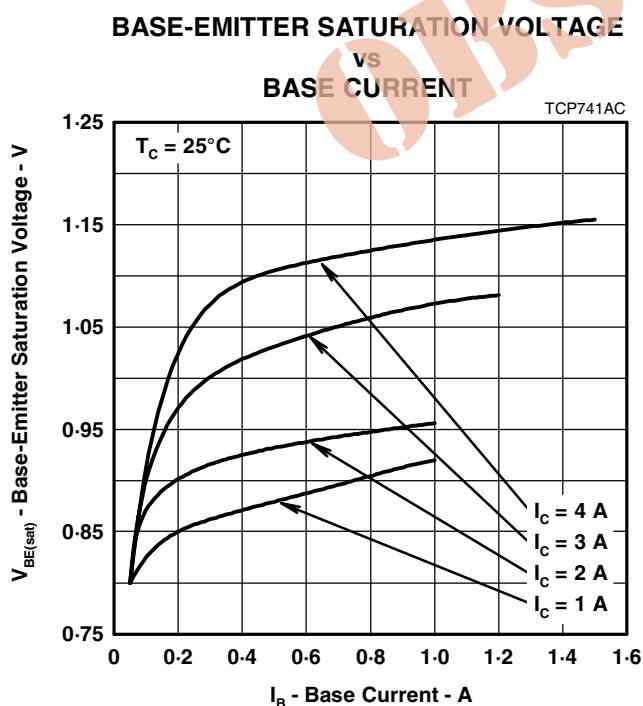


Figure 5.

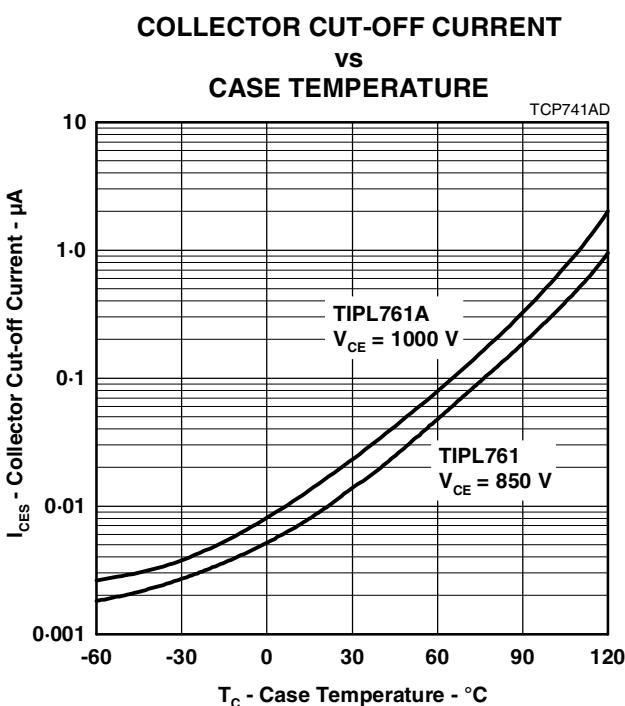


Figure 6.

PRODUCT INFORMATION

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## MAXIMUM SAFE OPERATING REGIONS

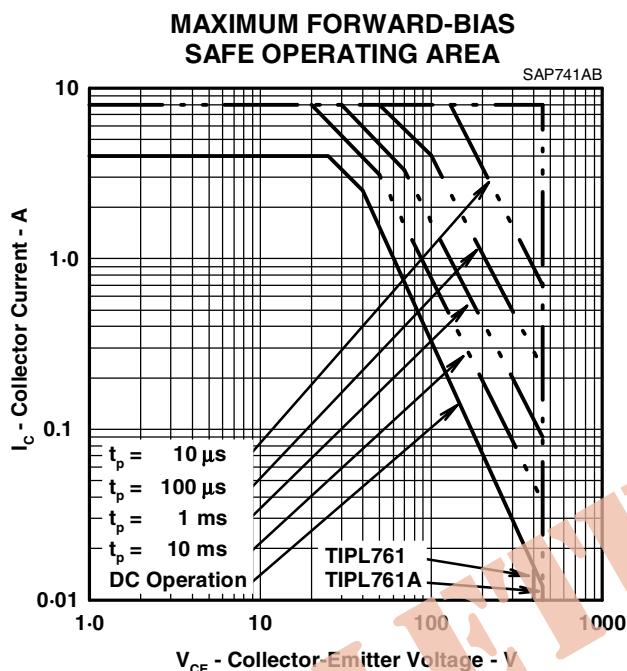


Figure 7.

## THERMAL INFORMATION

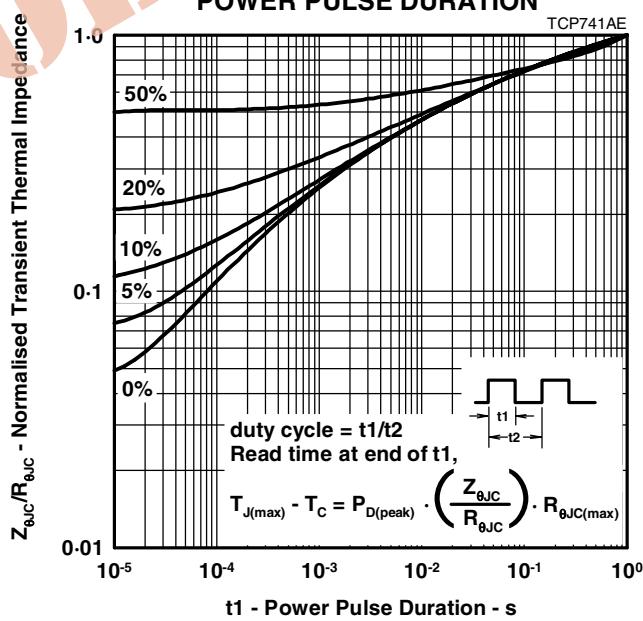
THERMAL RESPONSE JUNCTION TO CASE  
vs  
POWER PULSE DURATION

Figure 8.

## PRODUCT INFORMATION